



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

**PCN 20140802000
TLC5941QPWPRQ1 test
Information Only**

Date: 8/6/2014
To: MOUSER PCN

Dear Customer:

This is an information-only announcement of a change to a device that is currently offered by Texas Instruments.

The changes discussed within this PCN are for customer information only. Please note that implementation may occur immediately after notification.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (PCN_ww_admin_team@list.ti.com).

Sincerely,

PCN Team
SC Business Services
Phone: +1(214) 480-6037
Fax: +1(214) 480-6659

20140802000

Attachment: 1

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
TLC5941QPWPRQ1	null

PCN Number:	20140802000			PCN Date:	08/06/2014
Title:	TLC5941QPWPRQ1 test				
Customer Contact:	PCN Manager	Phone:	+1(214) 480-6037		Dept:
Change Type:	Quality Services				
<input type="checkbox"/> Assembly Site	<input type="checkbox"/> Design	<input type="checkbox"/> Wafer Bump Site			
<input type="checkbox"/> Assembly Process	<input type="checkbox"/> Data Sheet	<input type="checkbox"/> Wafer Bump Material			
<input type="checkbox"/> Assembly Materials	<input type="checkbox"/> Part number change	<input type="checkbox"/> Wafer Bump Process			
<input type="checkbox"/> Mechanical Specification	<input checked="" type="checkbox"/> Test Site	<input type="checkbox"/> Wafer Fab Site			
<input type="checkbox"/> Packing/Shipping/Labeling	<input type="checkbox"/> Test Process	<input type="checkbox"/> Wafer Fab Materials			
		<input type="checkbox"/> Wafer Fab Process			
PCN Details					
Description of Change:					
<p>Texas Instruments Incorporated is announcing an information only notification for test site change.</p> <ul style="list-style-type: none"> Move test operation from TI Malaysia to TI Taiwan. This will combine assembly and test operations to TI Taiwan. Test solution remains unchanged. Same tester platform, program, hardware, etc. 					
Reason for Change:					
<ul style="list-style-type: none"> Cycle time. Relieve capacity constraint in TI Malaysia. 					
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):					
None					
Changes to product identification resulting from this PCN:					
None.					
Product Affected:					
TLC5941QPWPRQ1					

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com